



A-F/2800

WMP-EUP-008

BOX AF

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450:

By: 

Date: 12/10/2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applic. No. : 10/056,770 Confirmation No. 4597  
Applicant : Gottfried Ferber et al.  
Filed : January 24, 2002  
TC/A.U. : 2818  
Examiner : Long K. Tran  
Title : Semiconductor Module and Method for  
Fabricating the Semiconductor Module

Docket No. : WMP-EUP-008  
Customer No. : 24131

BOX AF

Hon. Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

RECEIVED  
DEC 17 2003  
TECHNOLOGY CENTER 2800

**AMENDMENT under 37 C.F.R. § 1.116**

S i r :

In response to the final Office action dated September 10, 2003, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.

ok to enter  
WTF  
3/29/04